

N-channel 40 V, 1.2 mΩ standard level MOSFET in LFPAK88

6 August 2020

Product data sheet

1. General description

Automotive qualified N-channel MOSFET using the latest Trench 9 low ohmic superjunction technology, housed in a copper-clip LFPAK88 package. This product has been fully designed and qualified to meet beyond AEC-Q101 requirements delivering high performance and reliability.

2. Features and benefits

- Fully automotive qualified to beyond AEC-Q101:
- -55 °C to +175 °C rating suitable for thermally demanding environments
- LFPAK88 package:
 - Designed for smaller footprint and improved power density over older wire bond packages such as D²PAK for today's space constrained high power automotive applications
 - Thin package and copper clip enables LFPAK88 to be highly efficient thermally
- LFPAK copper clip technology enabling improvements over wire bond packages by:
 - Increased maximum current capability and excellent current spreading
 - Improved R_{DSon}
 - Low source inductance
 - Low thermal resistance R_{th}
- LFPAK Gull Wing leads:
 - Flexible leads enabling high Board Level Reliability absorbing mechanical and thermal cycling stress, unlike traditional QFN packages
 - · Visual (AOI) soldering inspection, no need for expensive x-ray equipment
 - Easy solder wetting for good mechanical solder joint
- Unique 40 V Trench 9 superjunction technology:
 - Reduced cell pitch and superjunction platform enables lower R_{DSon} in the same footprint
 - Improved SOA and avalanche capability compared to standard TrenchMOS
 - Tight V_{GS(th)} limits enable easy paralleling of MOSFETs

3. Applications

- 12 V automotive systems
- 48 V DC/DC systems (on 12 V secondary side)
- Higher power motors, lamps and solenoid control
- Reverse polarity protection
- LED lighting
- Ultra high performance power switching

4. Quick reference data

Table 1. Quick reference data								
Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
V _{DS}	drain-source voltage	$25 \text{ °C} \leq T_j \leq 175 \text{ °C}$		-	-	40	V	
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>	[1]	-	-	300	А	
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	-	294	W	

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit		
Tj	junction temperature			-55	-	175	°C		
Static characte	Static characteristics								
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; <u>Fig. 11</u>		0.74	1.06	1.2	mΩ		
Dynamic chara	Dynamic characteristics								
Q _{GD}	gate-drain charge	I_D = 25 A; V_{DS} = 32 V; V_{GS} = 10 V; Fig. 13; Fig. 14		-	14	28	nC		
Source-drain c	liode								
Q _r	recovered charge	$I_{\rm S}$ = 25 A; dI_{\rm S}/dt = -100 A/µs; V_{GS} = 0 V; V_{\rm DS} = 20 V	[2]	-	38	-	nC		
S	softness factor	$ I_{S} = 25 \text{ A}; \text{ dI}_{S}/\text{dt} = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V}; \\ \text{V}_{DS} = 20 \text{ V}; \text{ T}_{j} = 25 ^{\circ}\text{C} $		-	0.82	-			

[1] 300A continuous current has been successfully demonstrated during application. Practically the current will be limited by PCB, thermal design and operating emperature.

[2] includes capacitive recovery

5. Pinning information

Table 2. Pinning information								
Pin	Symbol	Description	Simplified outline	Graphic symbol				
1	G	gate		D				
2	S	source						
3	S	source	0	G (A Constraint of the second				
4	S	source		mbb076 S				
mb	D	mounting base; connected to drain	LFPAK88 (SOT1235)					

6. Ordering information

Table 3. Ordering information							
Type number Package							
	Name	Description	Version				
BUK7S1R2-40H	LFPAK88	plastic, single-ended surface-mounted package (LFPAK88); 4 leads; 2 mm pitch; 8 mm x 8 mm x 1.6 mm body	SOT1235				

7. Marking

Table 4. Marking codes	
Type number	Marking code
BUK7S1R2-40H	7S1R240H

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	40	V
V _{GS}	gate-source voltage	DC; T _j ≤ 175 °C		-10	20	V
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	294	W
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>	[1]	-	300	А
I _{DM}	peak drain current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$; Fig. 3		-	1341	А
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
Source-drain die	ode		-			
I _S	source current	T _{mb} = 25 °C	[2]	-	294	А
I _{SM}	peak source current	pulsed; t _p ≤ 10 µs; T _{mb} = 25 °C		-	1341	А
Avalanche rugg	edness		_		_	
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$ \begin{array}{l} {\sf I}_{\sf D} = 120 \; {\sf A}; \; {\sf V}_{sup} \leq \; 40 \; {\sf V}; \; {\sf R}_{\rm GS} = 50 \; \Omega; \\ {\sf V}_{\rm GS} = 10 \; {\sf V}; \; {\sf T}_{j({\sf init})} = 25 \; {\rm ^{\circ}C}; \; {\sf unclamped}; \\ \hline {\sf Fig. 4} \end{array} $	[3] [4]	-	277	mJ
I _{AS}	non-repetitive avalanche current	V_{sup} ≤ 40 V; V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; R _{GS} = 50 Ω; <u>Fig. 4</u>	[5]	-	199	A

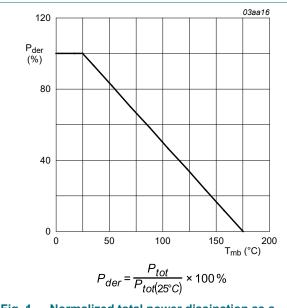
[1] 300A continuous current has been successfully demonstrated during application. Practically the current will be limited by PCB, thermal design and operating emperature.

[2] 294Å continuous current has been successfully demonstrated during application. Practically the current will be limited by PCB, thermal design and operating temperature.

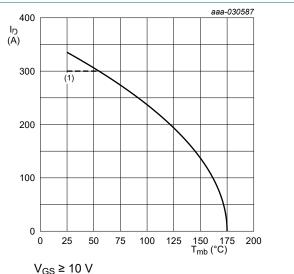
[3] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C.

[4] Refer to application note AN10273 for further information.

[5] Protected by 100% test.

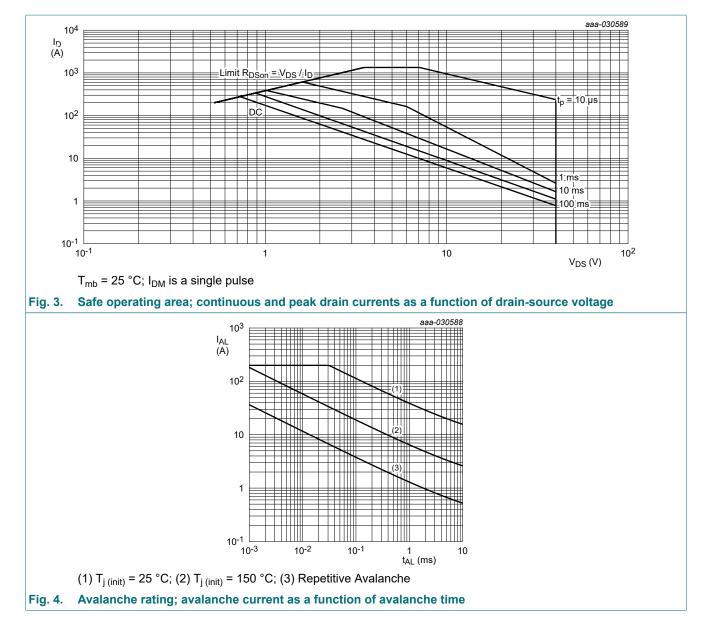






(1) 300A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

Fig. 2. Continuous drain current as a function of mounting base temperature

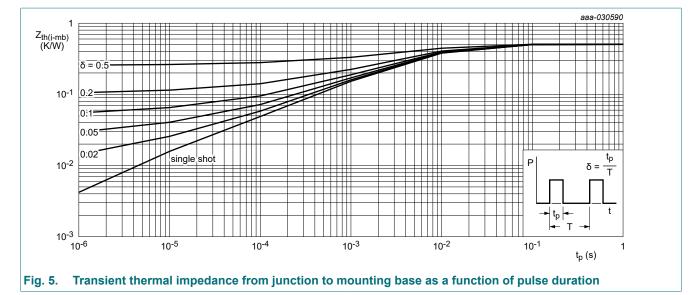


9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	<u>Fig. 5</u>	-	0.45	0.51	K/W

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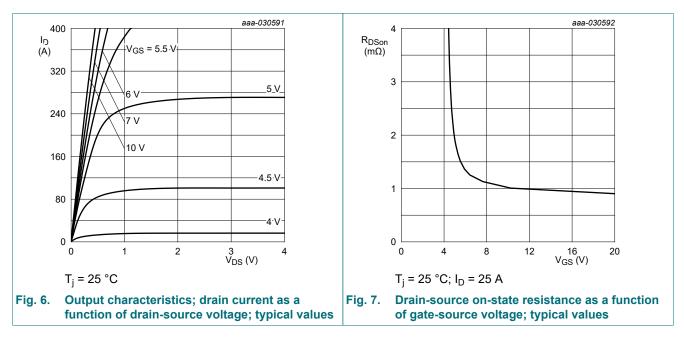
10. Characteristics

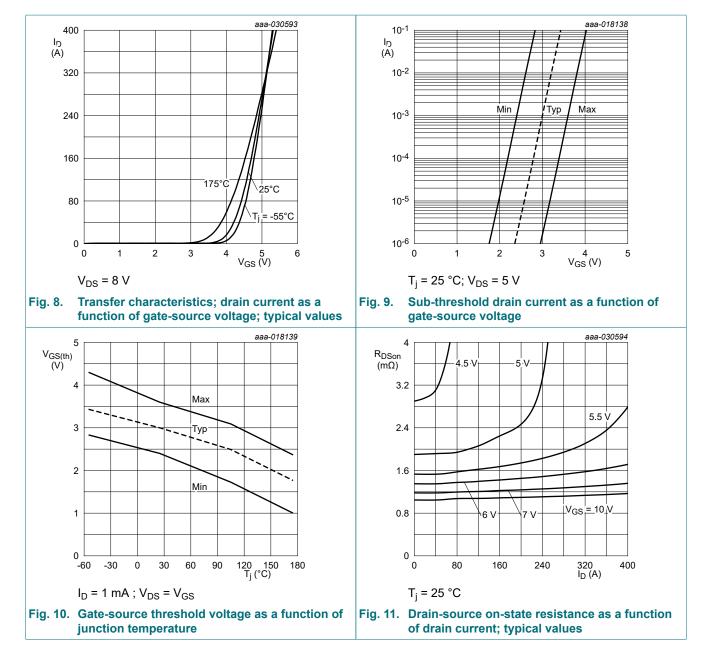
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	cteristics	· · ·				
V _{(BR)DSS}	drain-source	I _D = 250 μA; V _{GS} = 0 V; T _j = 25 °C	40	43	-	V
	breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _j = -40 °C	-	40.5	-	V
		I _D = 250 μA; V _{GS} = 0 V; T _j = -55 °C	36	40	-	V
V _{GS(th)}	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS}=V_{GS}; T_j = 25 \text{ °C}; Fig. 9;$ Fig. 10	2.4	3	3.6	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = -55 °C; <u>Fig. 10</u>	-	-	4.3	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 175 °C; <u>Fig. 10</u>	1	-	-	V
I _{DSS}	drain leakage current	V _{DS} = 40 V; V _{GS} = 0 V; T _j = 25 °C	-	0.06	1.2	μA
		V _{DS} = 16 V; V _{GS} = 0 V; T _j = 125 °C	-	1.6	25	μA
		V _{DS} = 40 V; V _{GS} = 0 V; T _j = 175 °C	-	180	500	μA
I _{GSS}	gate leakage current	V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
		V _{GS} = -10 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; Fig. 11	0.74	1.06	1.2	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 105 °C; Fig. 12	1.05	1.59	1.9	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 125 °C; Fig. 12	1.16	1.76	2.1	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 175 °C; Fig. 12	1.46	2.21	2.6	mΩ
R _G	gate resistance	f = 1 MHz; T _j = 25 °C	0.4	1.05	2.6	Ω
Dynamic ch	aracteristics		I			
Q _{G(tot)}	total gate charge	$I_D = 25 \text{ A}; V_{DS} = 32 \text{ V}; V_{GS} = 10 \text{ V};$	-	80	112	nC
Q _{GS}	gate-source charge	Fig. 13; Fig. 14	-	22	33	nC
Q _{GD}	gate-drain charge		-	14	28	nC

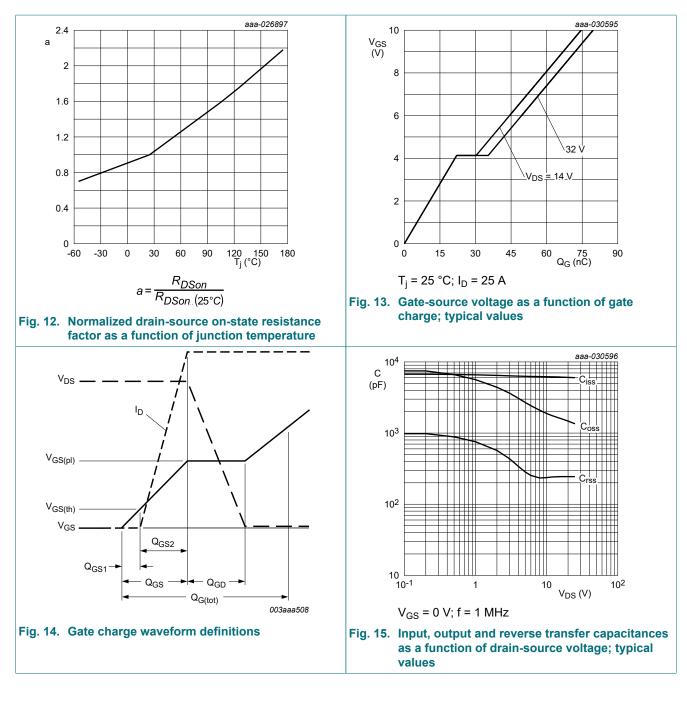
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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
C _{iss}	input capacitance	V _{DS} = 25 V; V _{GS} = 0 V; f = 1 MHz;		-	6014	8420	pF
C _{oss}	output capacitance	T _j = 25 °C; <u>Fig. 15</u>		-	1352	1893	pF
C _{rss}	reverse transfer capacitance			-	244	537	pF
t _{d(on)}	turn-on delay time	V_{DS} = 30 V; R _L = 1.2 Ω; V _{GS} = 10 V;		-	19	-	ns
t _r	rise time	$R_{G(ext)} = 5 \Omega$		-	16	-	ns
t _{d(off)}	turn-off delay time			-	50	-	ns
t _f	fall time			-	22	-	ns
Source-dra	in diode	,					
V _{SD}	source-drain voltage	I_{S} = 25 A; V_{GS} = 0 V; T_{j} = 25 °C; <u>Fig. 16</u>		-	0.77	1	V
t _{rr}	reverse recovery time	I _S = 25 A; dI _S /dt = -100 A/μs; V _{GS} = 0 V;		-	39	-	ns
Q _r	recovered charge	V _{DS} = 20 V	[1]	-	38	-	nC
S	softness factor	$I_{S} = 25 \text{ A}; \text{ d}I_{S}/\text{d}t = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V}; \\ \text{V}_{DS} = 20 \text{ V}; \text{ T}_{j} = 25 ^{\circ}\text{C}$		-	0.82	-	
	$I_{\rm S} = 25 \text{ A}; \text{ dI}_{\rm S}/\text{dt} = -100 \text{ d}$	I_{S} = 25 A; dI _S /dt = -500 A/µs; V _{GS} = 0 V; V _{DS} = 20 V; T _j = 25 °C		-	0.73	-	

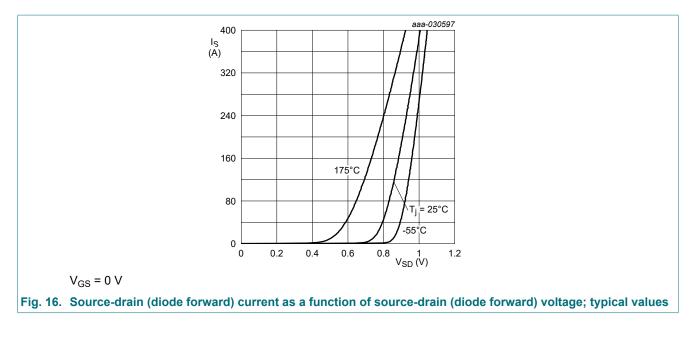
[1] includes capacitive recovery



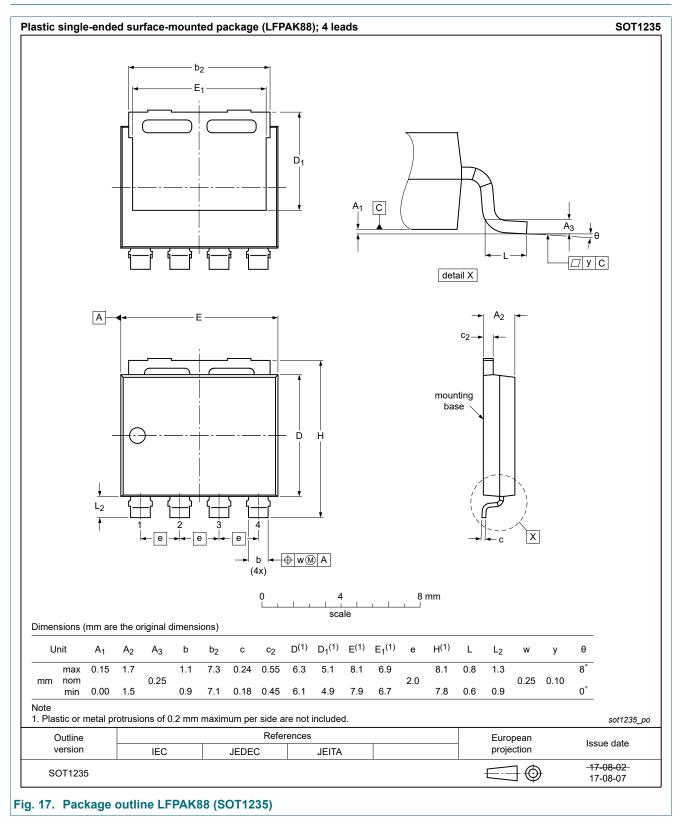




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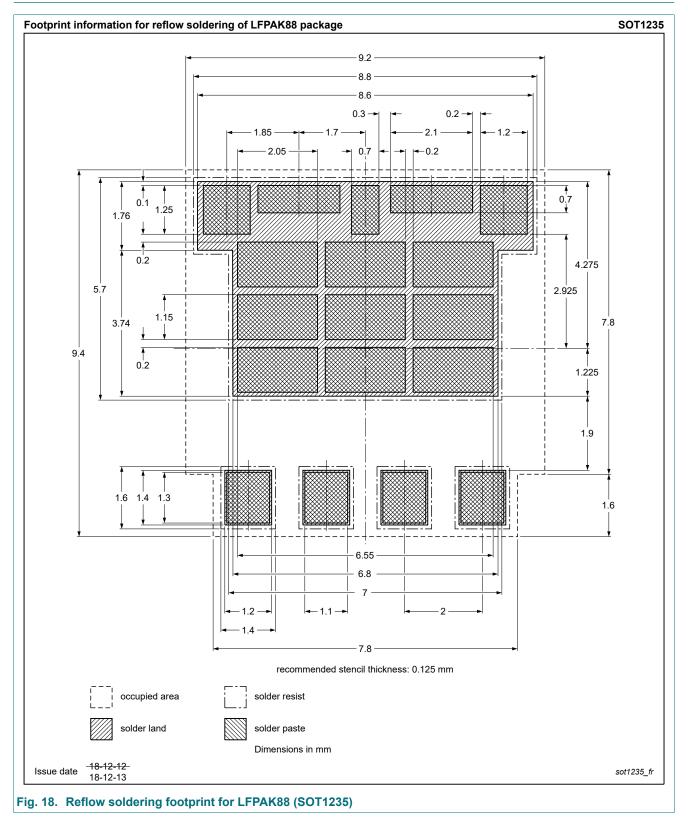


11. Package outline



Product data sheet

12. Soldering



13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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